

FEATURES

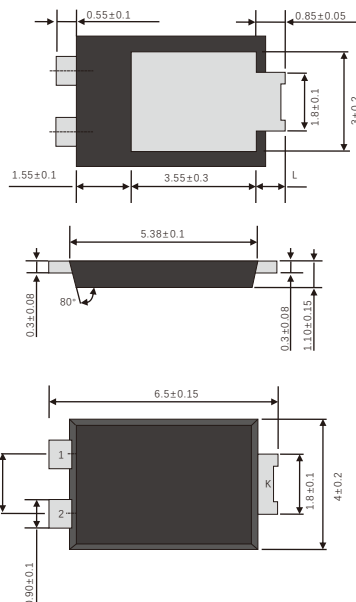
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- Very low profile-typical height of 1.1mm
- Ideal for automated placement
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2015/863/EU



MECHANICAL DATA

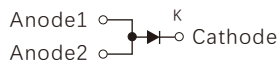
- Case: TO-277 molded plastic body
- Terminals: Plated axial leads, solderable per MIL-STD-750,method 2026
- Mounting Position: Any
- Weight: 0.092 grams(approx)

TO-277



TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications



Dimensions in inches and (millimeters)

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	200	V
Maximum average forward rectified current	$I_{F(AV)}$	15.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	200	A
Operating junction temperature range	T_J	-55 to+150	°C
Storage temperature range	T_{stg}	-55 to+150	°C

RATINGS AND CHARACTERISTIC OF SP15U200L

Electrical Characteristcs (T_A=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	Typ.	Max.	Unit
Instaneous forward voltage	T _J =25°C	I _F =2A	V _F 1)	0.63	-	V
		I _F =10A		0.78	-	
		I _F =15A		0.82	0.90	
	T _J =125°C	I _F =2A		0.48	-	
		I _F =10A		0.64	-	
		I _F =15A		0.70	-	
Reverse current	V _R =200V	T _J =25°C	I _R 2)	2.0	20	μA
		T _J =100°C		0.5	-	mA
		T _J =125°C		2.0	-	
Typical junction capacitance	4V,1MHz		C _J	272		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle
2.Pulse test: pulse width ≤40ms

Thermal Characteristics

Parameter	Symbol	TO-277	Unit
Typical thermal resistance 3)	R _{θJA}	60.0	°C/W
	R _{θJL}	3.0	

3 Units mounted on recommended PCB 1 oz. Pad layout

Availabale Pack Information

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Box Size L×W×H (mm)	Quantity (reel/box)	Carton Size L×W×H (mm)	Quantity (box/carton)
SP15U200L-TO-277	T/R	φ330	5000	338×338×40	2	365×365×360	7

Fig.1-Forward Current Derating Curve

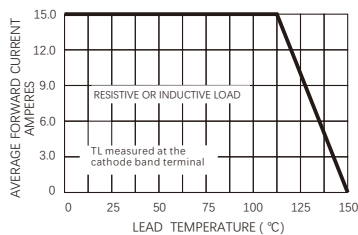


Fig.2-Maximum Non-repetitive Peak Forward Surge Current

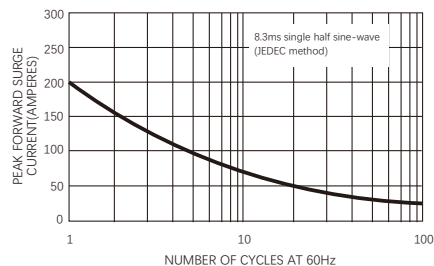


Fig.3-Typical Instantaneous Forward Characteristics

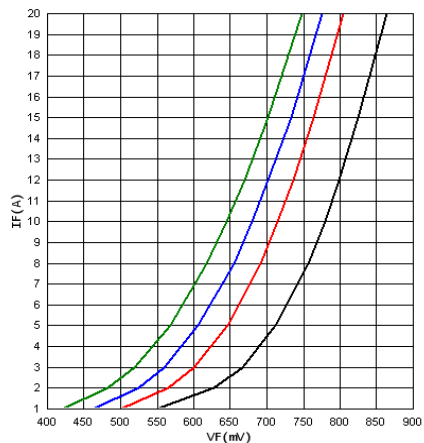


Fig.4-Typical Reverse Characteristics

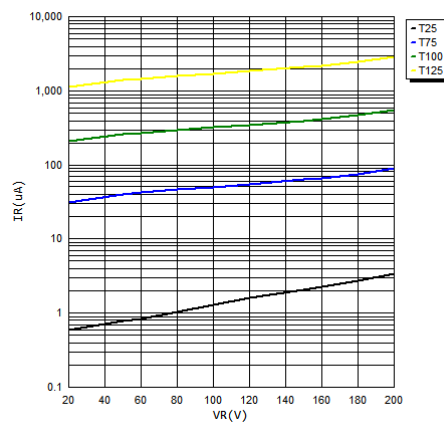
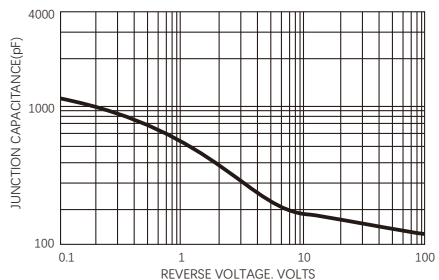
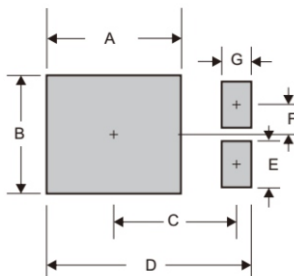


Fig.5-Typical Junction Capacitance



Suggested Pad

■ TO-277 foot print



A	B	C	D	E	F	G
0.185 (4.70)	0.142 (3.60)	0.152 (3.87)	0.260 (6.60)	0.055 (1.40)	0.035 (0.90)	0.031 (0.80)

Dimensions in inches and (millimeters)

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